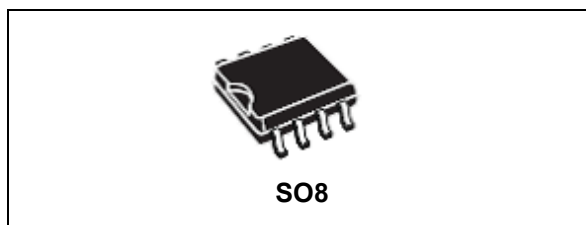


Offline PWM controller for low standby adapters

Datasheet - production data



- Input voltage feedforward compensation for mains-independent CC regulation
- Embedded thermal shutdown
- Intelligent frequency jitter for EMI suppression
- SO8 package

Features

- Advanced power management for ultra-low standby power consumption (under 10 mW at 230 VAC)
- Fully integrated primary side constant current output regulation (CC)
- 650 V embedded HV start-up circuit with zero power consumption.
- Quasi-resonant (QR) zero-voltage-switching (ZVS) operation
- Accurate and adjustable output OVP with options auto-restart (STCH03) or latched (STCH03L) after fault
- Output undervoltage protection (UVP) with auto-restart

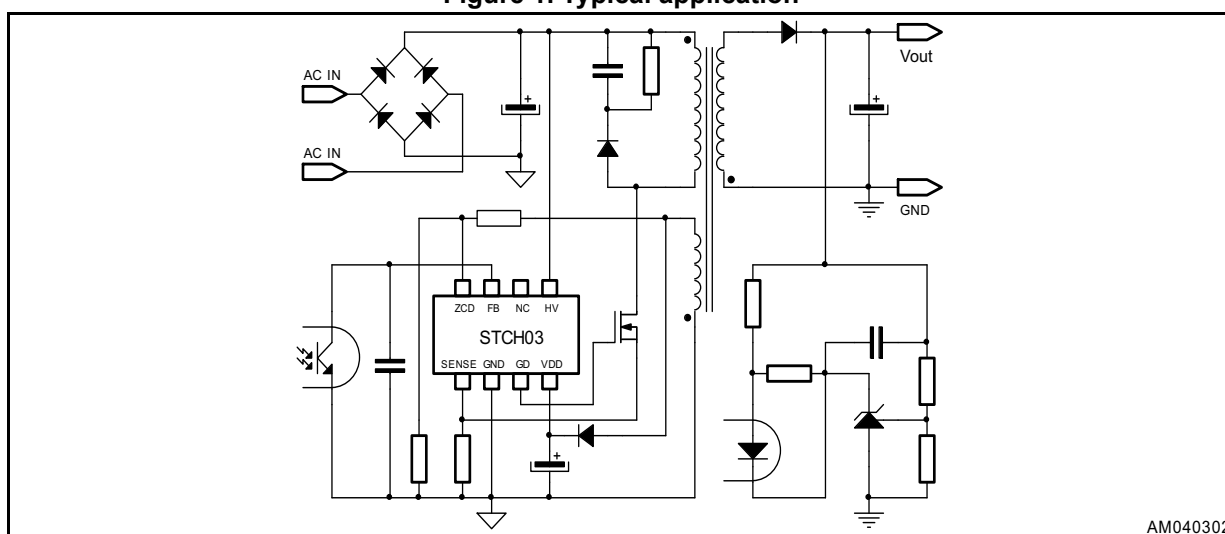
Applications

- AC-DC chargers for smartphones, tablets, camcorders and other handheld equipment
- AC/DC adapters for STB, notebooks and auxiliary power supplies
- Quick charger

Table 1. Device summary

| Order codes | Package | Packaging |
|-------------|---------|---------------|
| STCH03 | SO8 | Tube |
| STCH03L | | |
| STCH03TR | | Tape and reel |
| STCH03LTR | | |

Figure 1. Typical application



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1 Description

The STCH03 current-mode controller is designed for an offline quasi-resonant ZVS (zero-voltage-switching at switch turn-on) flyback converter.

It combines a high-performance low-voltage PWM controller chip and a 650V HV start-up cell in the same package.

The device features a unique characteristic: it is capable of providing constant output current (CC) regulation using primary-sensing feedback. This eliminates the need for dedicated current reference IC, as well as the current sensor, still maintaining quite accurate output current regulation.

The quasi-resonant operation is achieved by means of a transformer demagnetization sensing input that triggers the turn-on of the MOSFET, connected on the ZCD pin. This input serves also as both output voltage monitor, to achieve mains-independent CC regulation (line voltage feedforward), and to implement OVP and UVP.

The maximum switching frequency is top-limited below 167 kHz, so that at the medium-light load a special function automatically lowers the operating frequency whilst still maintaining the operation as close to ZVS as possible. At the very light load, the device enters a controlled burst-mode operation that, along with the zero-power high-voltage start-up circuit, the extremely low quiescent current of the device, helps minimize the residual input consumption, thus meeting the requirements of the most stringent standards.

During the burst-mode operation the V_{DD} supply voltage has to be guaranteed by optimum application design. In any case, an innovative adaptive UVLO helps to minimize the issues related to the fluctuations of the auxiliary biasing voltage with the output load, due to parasitic capacitance of the transformer and further reducing the IC's bias consumption.

In addition to these functions that optimize power handling under different operating conditions, the device also offers the output overvoltage protection (OVP), overtemperature protection (OTP), hiccup-mode protection that is invoked when the transformer saturates or the secondary diode fails short and the output UVP protection that limits the average output current in case of the output short-circuit. All the protections are auto-restart mode, except the OVP protection, that can be internally selected to be auto-restart or latched mode.

The embedded leading-edge blanking on the current sense input for greater noise immunity completes the equipment of this device.

2 Thermal data

Table 2. Thermal data

| Symbol | Parameter | Max. value | Unit |
|-----------------|---|------------|------|
| $R_{th\ j-amb}$ | Thermal resistance, junction to ambient | 150 | °C/W |

3 Absolute maximum ratings

Table 3. Absolute maximum ratings

| Symbol | Pin | Parameter | Value | Unit |
|-----------|--------|---|--------------|------|
| V_{HV} | 1 | Voltage range (referred to GND) | -0.3 to 650 | V |
| I_{HV} | 1 | Charging current | Self-limited | mA |
| - | 3 to 6 | Analog inputs and outputs | -0.3 to 3.6 | V |
| I_{ZCD} | 4 | Zero current detector current | ± 3 | mA |
| I_{GD} | 6 | Output totem pole peak current | Self-limited | - |
| V_{DD} | 8 | Supply voltage ($I_{CC} < 25\text{ mA}$) | Self-limited | V |
| I_{DD} | 8 | Device supply current + internal Zener capability | 25 | mA |
| T_J | | Junction temperature range | -40 to 150 | °C |
| T_{STG} | | Storage temperature | -55 to 150 | °C |

4 Pin connection and functions

Figure 2. Pin connection (top view)

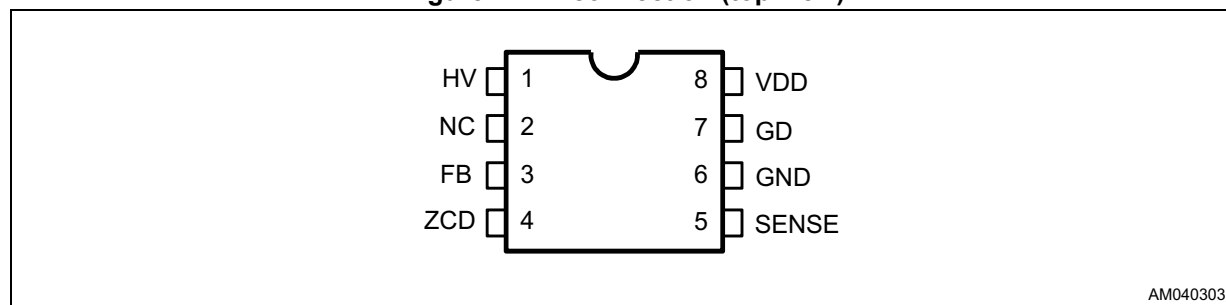


Table 4. Pin functions

| No. | Name | Function |
|-----|----------|--|
| 1 | HV | High-voltage start-up. This pin is able to withstand 650 V and is tied directly to the rectified mains voltage. When the voltage on the pin reaches the HV_{START} voltage (50 V typ.) a 7 mA internal current source charges the capacitor connected between V_{DD} and GND to start-up the IC. When the voltage on the V_{DD} pin reaches the turn-on threshold (17 V typ.) the generator is shut down. |
| 2 | NC | Not internally connected. Provision for clearance on the PCB to meet safety requirements. |
| 3 | FB | Control input for duty cycle control. A voltage set 65 mV below the threshold V_{FBB} activates the burst-mode operation. A level close to the threshold V_{FBH} means that we are approaching the cycle-by-cycle overcurrent set point. |
| 4 | ZCD | The transformer demagnetization sensing for quasi-resonant operation and input/output voltage monitor. A negative-going edge triggers the MOSFET turn-on. The current sourced by the pin during the MOSFET ON time is monitored for an image of the input voltage to the converter, in order to compensate the internal delay of the current sensing circuit and achieve a CC regulation independent of the mains voltage. At the same time the pin voltage is sampled-and-held right at the end of the transformer demagnetization to get an accurate image of the output voltage to be used for overvoltage protection (OVP) and undervoltage protection (UVP) sensing. Please note that maximum I_{ZCD} sink/source current must not exceed 3 mA over the entire voltage range. No capacitor is allowed between the pin and the auxiliary winding of the transformer. |
| 5 | SENSE | Input to the PWM comparators. The current flowing in the MOSFET is sensed through a resistor connected between the pin and GND. The resulting voltage is compared with an internal reference (0.75 V typ.) to determine MOSFET turn-off. The pin is equipped with 380 ns blanking time after the gate-drive output goes high for improved noise immunity. If a second comparison level located at 1 V, is exceeded, the IC stops and restarts after V_{DD} has dropped below V_{DDR} (4.5 V typ.). |
| 6 | GND | Circuit ground reference and current return for both the signal part of the IC and the gate-drive. All of the ground connections of the bias components should be tied to an interconnect going to this pin and kept separate from any pulsed current return. |
| 7 | GD | Gate-driver with the totem pole output stage for the external power MOSFET. |
| 8 | V_{DD} | Supply voltage of the device. An electrolytic capacitor, connected between this pin and ground, is initially charged by the internal high-voltage start-up generator. It is recommended to place a small bypass capacitor (0.1 μ F typ.) connected between the pin and GND might be useful to get a clean bias voltage for the signal part of the IC. To improve the ruggedness of the pin during electrical fast transient events, an RC low-pass filter can be also connected on the pin. |

5 Electrical characteristics

$T_j = -25\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$, $V_{DD} = 14\text{ V}^{(a)}$, unless otherwise specified

Table 5. Electrical characteristics

| Symbol | Parameter | Test condition | Min. | Typ. | Max. | Unit |
|---|------------------------------------|--|------|------|-------|---------------|
| HIGH-VOLTAGE START-UP GENERATOR | | | | | | |
| V_{HV} | HV voltage | $I_{HV} < 2\text{ }\mu\text{A}$, $T_j = 25\text{ }^{\circ}\text{C}$ | - | - | 650 | V |
| $I_{LEAKAGE}$ | HV leakage current | $V_{HV} = 400\text{ V}$, $T_j = 25\text{ }^{\circ}\text{C}$ | - | - | 1 | μA |
| HV_{START} | HV start voltage | - | 40 | 50 | 60 | V |
| I_{CHARGE} | V_{DD} startup charge current | $V_{HV} > H_{VSTART}$; $V_{DD} \leq V_{DD_FOLD}$ | 0.3 | 0.6 | 0.9 | mA |
| | | $V_{HV} > H_{VSTART}$; $2\text{ V} < V_{DD} < V_{DDON}$ | 4.5 | 7 | 10.3 | |
| $V_{DD-FOLD}$ | V_{DD} foldback threshold | $V_{HV} > HV_{START}$ | 1 | 1.4 | 2 | V |
| SUPPLY VOLTAGE | | | | | | |
| V_{DD} | Operating range | After turn-on | 11.5 | - | 23 | V |
| V_{DD-ON} | Turn-on threshold | - | 15.7 | 17 | 18.3 | V |
| V_{DD-OFF} | Restart threshold | $V_{FB} > V_{FBF}$ | 9 | 10 | 11 | V |
| $V_{DD-UVLO}$ | UVLO threshold | $V_{FB} > V_{FBF}$ | 8.55 | 9.5 | 10.45 | V |
| | | $V_{FB} < (V_{FBF} - 65\text{ mV})$ | 6.75 | 7.5 | 8.25 | V |
| V_{DDR} | V_{DD} restart voltage (falling) | After protection tripping | - | 4.5 | - | V |
| | | In burst-mode | - | 3.2 | - | |
| V_Z | V_Z clamping voltage | $I_{DD} = 25\text{ mA}$ | 23 | - | 26.5 | V |
| SUPPLY CURRENT | | | | | | |
| I_Q | Quiescent current | Burst operation | - | 290 | 335 | μA |
| I_{DD} | Operating supply current | $C_{GATE} = 1\text{ nF}$, $F_{SW} = 100\text{ KHz}$ | - | 2.5 | 2.9 | mA |
| $I_{DD-FAULT}$ | Fault quiescent current | OCP, OVP, UVO, OTP | - | 330 | 420 | μA |
| START-UP TIMER AND FREQUENCY LIMIT | | | | | | |
| T_{START} | Start timer period | - | - | 220 | - | μs |
| F_{LIM_MAX} | Max. internal frequency limit | - | 145 | 167 | 196 | kHz |
| ZERO CURRENT DETECTOR | | | | | | |
| I_{ZCDB} | Input bias current | $V_{ZCD} = 0.1\text{ to }2.7\text{ V}$ | - | - | 1 | μA |
| V_{ZCDH} | Upper clamp voltage | $I_{ZCD} = 1\text{ mA}$ | 2.7 | 3 | 3.5 | V |
| V_{ZCDL} | Lower clamp voltage | $I_{ZCD} = -1\text{ mA}$ | -90 | -60 | -30 | mV |
| V_{ZCDA} | Arming voltage | Positive-going edge | 100 | 110 | 120 | mV |

a. Adjust V_{DD} above V_{DD-ON} start-up threshold before settings to 14 V.

Table 5. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Typ. | Max. | Unit |
|--------------------------------|--|--|-------|------|-------|------------------|
| V_{ZCDT} | Triggering voltage | Negative-going edge | 50 | 60 | 70 | mV |
| T_{BLANK} | Trigger blanking time after MOSFET turn-on | $V_{FB} \geq 1.65 \text{ V}$ | 4.3 | 5.7 | 7.1 | μs |
| | | $V_{FB} = 0.6 \text{ V}$ | 27.2 | 32 | 36.8 | |
| T_{D-ON} | Turn-on delay time after triggering | $V_{GATE} = 6 \text{ V}$, $C_{GATE} = 1 \text{ nF}$ | - | 270 | - | ns |
| T_{FORCE} | Force turn-on time after blanking | - | 5.1 | 6 | 6.9 | μs |
| LINE FEEDFORWARD | | | | | | |
| R_{FF} | Equivalent feedforward resistor | $I_{ZCD} = 1 \text{ mA}$ | 60 | 70 | 80 | Ω |
| GATE-DRIVER | | | | | | |
| V_{GDL} | Output high voltage | $V_{DD} = 8.5 \text{ V}$; $I_{GATE} = 5 \text{ mA}$ | 7 | - | - | V |
| | | $I_{GATE} = 5 \text{ mA}$ | 10.5 | 13 | - | |
| T_{RISE} | Rising time | $C_{GATE} = 1 \text{ nF}$ | 70 | 110 | 150 | ns |
| T_{FALL} | Falling time | $C_{GATE} = 1 \text{ nF}$ | 20 | 40 | 60 | ns |
| V_{GDL} | Output low voltage | $I_{GD-SINK} = 50 \text{ mA}$ | - | - | 1 | V |
| FEEDBACK INPUT | | | | | | |
| V_{FBH} | Upper saturation | - | - | 3.45 | - | V |
| H_{FB} | Current sense gain | - | 3.22 | 3.29 | 3.36 | - |
| I_{FB} | Feedback source current | - | 70 | 100 | 130 | μA |
| R_{FB} | Dynamic feedback resistor | - | 25 | 30 | 41 | $\text{k}\Omega$ |
| V_{FBR} | Frequency reduction threshold | - | 1.4 | 1.65 | 1.9 | V |
| V_{FBB} | Burst-mode threshold | ⁽¹⁾ Voltage falling | 0.54 | 0.6 | 0.66 | V |
| V_{FBF} | Exit burst-mode threshold | ⁽¹⁾ | 0.64 | 0.72 | 0.8 | V |
| V_{HYST} | Burst-mode hysteresis | - | 50 | 65 | 75 | mV |
| CURRENT REFERENCE | | | | | | |
| V_{REFx} | Maximum value | Internal, not measured | - | 0.8 | - | V |
| K_I | Current loop gain | - | 0.19 | 0.2 | 0.21 | V |
| OVERVOLTAGE PROTECTION | | | | | | |
| V_{OVP} | OVP threshold | - | 2.375 | 2.5 | 2.625 | V |
| N_{OVP} | Consecutive cycles for OVP triggering | $V_{OVP} = 2.5 \text{ V}$ | - | 4 | - | - |
| UNDERVOLTAGE PROTECTION | | | | | | |
| V_{UVP} | UVP threshold | - | 0.522 | 0.55 | 0.578 | V |
| T_{UVP} | UVP blanking time | - | 12 | 20 | 28 | ms |
| N_{UVP} | Consecutive cycles for UVP triggering | $V_{UVP} = 0.55 \text{ V}$ | - | 4 | - | - |

Table 5. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Typ. | Max. | Unit |
|----------------------------|----------------------------------|--|------|------|------|------|
| CURRENT SENSE | | | | | | |
| T_{LEB} | Leading-edge blanking | ⁽¹⁾ $V_{GATE} = 6\text{ V}$, $C_{OUT} = 1\text{ nF}$ | 270 | 380 | 490 | ns |
| T_D | Gate delay-to-output | ⁽¹⁾ $V_{GATE} = 6\text{ V}$, $C_{OUT} = 1\text{ nF}$ | - | - | 150 | ns |
| V_{CSx} | Max. clamp value | ⁽¹⁾ $dV_{CS}/dt = 200\text{ mV}/\mu\text{s}$ | 0.7 | 0.75 | 0.8 | V |
| V_{OCP} | Hiccup-mode OCP level | ⁽¹⁾ | 0.95 | 1 | 1.05 | V |
| V_{SENSE_BM} | Minimum burst-mode sense voltage | - | - | 72 | - | mV |
| FREQUENCY JITTERING | | | | | | |
| F_D | Modulation frequency | - | - | 9 | - | kHz |
| V_{ZCDH} | Modulation duty cycle | - | - | 50 | - | % |
| ΔI_{pk} | Peak current change | - | - | 5 | - | % |
| THERMAL SHUTDOWN | | | | | | |
| T_{SD} | Thermal shutdown temperature | Guaranteed by design and characterization | 135 | 150 | 165 | °C |
| T_{HYST} | Thermal shutdown hysteresis | Guaranteed by design and characterization | - | 30 | - | °C |

1. Adjust V_{DD} above V_{DD-ON} start-up threshold before settings to 14 V.

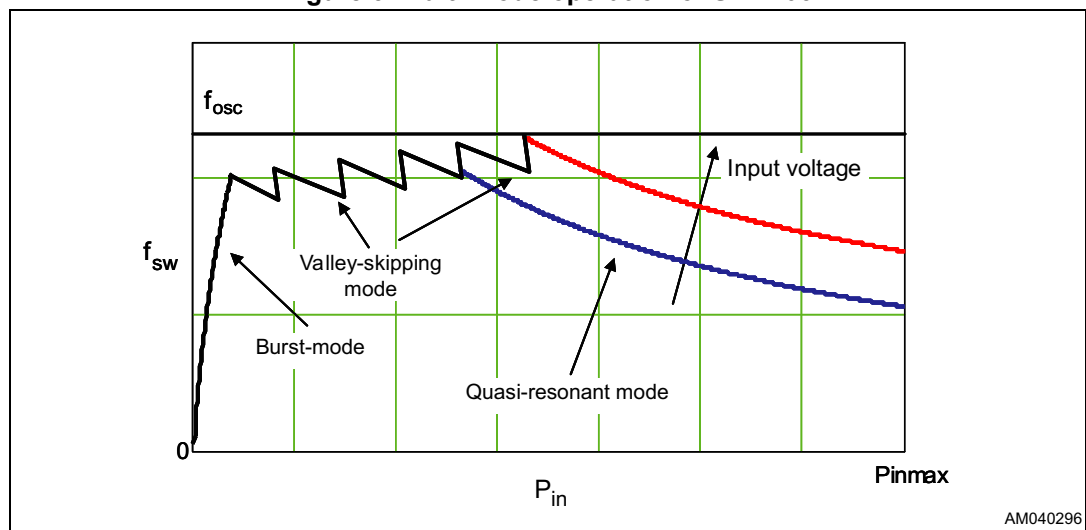
6 Application information

The STCH03 is an off-line CC-mode primary sensing switching controller, specific for offline quasi-resonant ZVS (zero-voltage-switching at switch turn-on) flyback converters.

Depending on converter's load condition, the device is able to work in different modes (see [Figure 3](#)):

1. QR mode at heavy load. Quasi resonant operation is achieved by synchronizing the MOSFET turn-on to the transformer demagnetization by detecting the resulting negative-going edge of the voltage across any winding of the transformer. Then the system works close to the boundary between discontinuous (DCM) and continuous conduction (CCM) of the transformer. As a result, the switching frequency will be different for different line/load conditions (see the hyperbolic-like portion of the curves in [Figure 3](#)). The minimum turn-on losses, low EMI emission and safe behavior in short-circuit are the main benefits of this kind of operation.
2. Valley-skipping mode at medium/ light load. Depending on voltage on the FB pin, the device defines the maximum operating frequency of the converter. As the load is reduced the MOSFET turn-on will no longer occur on the first valley but on the second one, the third one and so on. In this way the switching frequency will no longer increase.
3. Burst-mode with no or very light load. When the load is extremely light or disconnected, the converter will enter a controlled on/off operation with constant peak current. Decreasing the load will then result in frequency reduction, which can go down even reduce to a few hundred hertz, thus minimizing all frequency-related losses and making it easier to comply with energy saving regulations or recommendations. As the peak current is very low, no issue of audible noise arises.

Figure 3. Multi-mode operation of STCH03



AM040296

6.1 Gate-driver

The gate-driver of the power MOSFET is designed to supply a controlled gate current during both turn-on and turn-off in order to minimize the common mode EMI. Under UVLO conditions an internal pull-down circuit holds the gate low in order to ensure that the power MOSFET cannot be turned on accidentally.

6.2 Frequency jittering for EMI reduction

Although the STCH03 works in the QR mode and the switching frequency is already modulated at twice the mains frequency, a dedicated frequency jittering circuitry is embedded inside the IC to further reduce the EMI filtering. A proprietary frequency jitter technique is implemented in the controller, based on the injection of a modulating signal at 9 kHz (above the feedback loop bandwidth) with the 50% duty cycle on the current sense signal: this signal is a square waveform that modulates the amplitude of the peak primary current. The percentage of this amplitude is set at 5% as default. As the peak current reduces with decreasing load levels, the effect of this modulation automatically attenuates at lower loads, where the energy of EMI noise is highly reduced.

6.3 High voltage startup generator

Based on a 650 V rated depletion MOSFET embedded into the start-up cell, the HV current generator is supplied through the DRAIN pin and is enabled only if the voltage on the HV pin is higher than the HV_{START} threshold (50 V typical value).

When the power is applied to the circuit and the voltage on the input bulk capacitor is high enough, the HV generator is sufficiently biased to start operating, thus it will draw the current I_{CHARGE} (7 mA typ. value) through the HV pin and will charge the capacitor connected between the V_{DD} pin and ground. This charging current will be reduced at 0.6 mA in case the voltage on V_{DD} is lower than V_{DD_FOLD} , in order to prevent exceeding the IC dissipation when the pin is accidentally shorted to ground.

As the V_{DD} voltage reaches the start-up threshold (17 V typ.) the chip starts operating and the control logic disables the HV generator.

While the generator is off, there are virtually no losses across the HV start-up cell, except a few hundred nA of leakage current through the depletion MOSFET.

The IC is powered by the energy stored in the V_{DD} capacitor until the auxiliary winding develops a voltage high enough to sustain the operation.

At converter power-down the system will lose regulation as soon as the input voltage falls below HV_{START} . This prevents the converter restarting and ensures the monotonic output voltage decay at system power-down.

To increase the ruggedness of the HV pin during electrical fast transient events it is suggested a 47 k Ω resistor between the HV pin and the mains.

6.4 Zero current detection and triggering block

The zero current detection (ZCD) and triggering blocks switch on the power MOSFET if a negative-going edge falling below 60 mV is applied to the ZCD pin. To do so, the triggering block must be previously armed by a positive-going edge exceeding 110 mV.

This feature is used to detect transformer demagnetization for the QR operation, where the signal for the ZCD input is obtained from the transformer auxiliary windings used also to supply the IC.

The triggering block is blanked after MOSFET turn-on to prevent any negative-going edge that follows leakage inductance demagnetization from triggering the ZCD circuit erroneously.

The switching frequency is top-limited below 167 kHz.

To prevent the tendency of the system to excessively increase the frequency at the light load and high input voltage, a variable blanking time function is implemented.

This blanking time is dependent on the voltage on the FB pin: it is $T_{\text{BLANK}} = 32 \mu\text{s}$ for $V_{\text{FB}} = 0.6 \text{ V}$, and decreases linearly down to $T_{\text{BLANK}} = 5.7 \mu\text{s}$ for $V_{\text{FB}} \geq 1.65 \text{ V}$. In this way, the switching frequency is progressively reduced, resulting in lower frequency-related losses.

If the demagnetization completes - hence a negative-going edge appears on the ZCD pin - after a time exceeding time T_{BLANK} from the previous turn-on, the MOSFET will be turned on again, with some delay to ensure minimum voltage at turn-on ("*QR mode*").

If, instead, the negative-going edge appears before T_{BLANK} has elapsed, it will be ignored and only the first negative-going edge after T_{BLANK} will turn-on the MOSFET. In this way one or more drain ringing cycles will be skipped ("*valley-skipping mode*") and the switching frequency will be prevented from exceeding $1/T_{\text{BLANK}}$.

The blanking time limits and the mode of operation are reported in [Figure 4](#).

A forced turn-on time function is implemented in case the residual oscillation on ZCD are not enough to trigger again the switching, during the low frequency operation: the power MOSFET is forced to turn-on 6 μs (typical value) after the blanking time is elapsed.

A starter block is also used to start-up the system when the signal on the ZCD pin is not high enough to trigger the MOSFET.

After the first few cycles initiated by the starter, as the voltage developed across the auxiliary winding becomes large enough to arm the ZCD circuit, the MOSFET's turn-on will start to be locked to transformer demagnetization, hence setting up the QR operation.

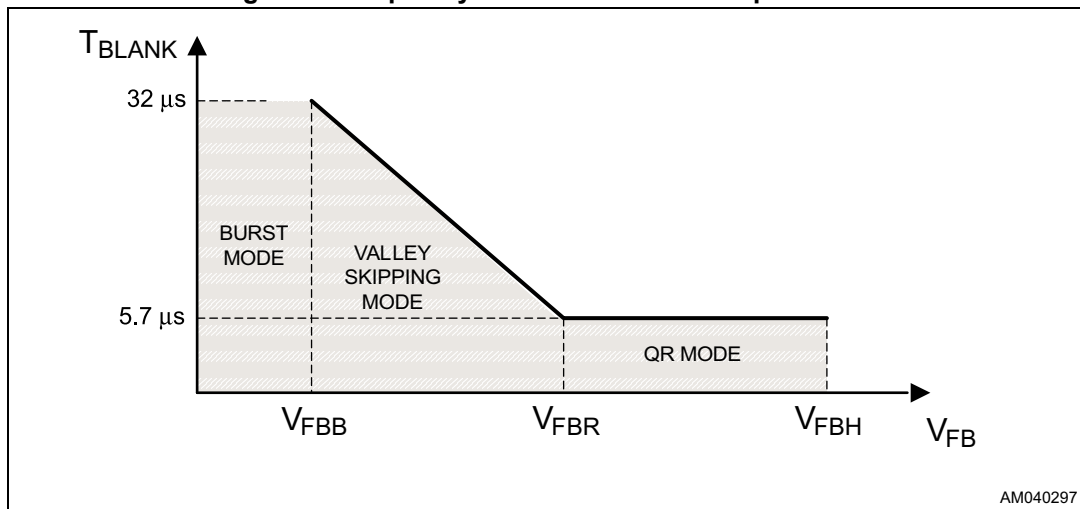
The starter is activated also when the IC is in CC regulation and the output voltage is not high enough to allow the ZCD triggering.

The voltage on the ZCD pin is both top and bottom limited by a double clamp. The upper clamp is typically located at 3 V, while the lower clamp is located at -60 mV. The interface between the pin and the auxiliary winding will be a resistor divider. Its resistance ratio as well as the individual resistance values will be properly chosen (see [Section 6.10: Overvoltage protection on page 16](#) and [Section 6.7: Voltage feedforward block on page 14](#)).

Please note that the maximum I_{ZCD} sink/source must not exceed $\pm 3 \text{ mA}$ (AMR) in all the input voltage range conditions (88 - 265 VAC). No capacitor is allowed between the ZCD pin and the auxiliary winding of the transformer.

Note that when the system operates in the valley skipping-mode, uneven switching cycles may be observed under some line/load conditions, due to the fact that the OFF-time of the MOSFET is allowed to change with discrete steps of one ringing cycle, while the OFF-time needed for cycle-by-cycle energy balance may fall in between. Thus one or more longer switching cycles will be compensated by one or more shorter cycles and vice versa. However, this mechanism is absolutely normal and there is no appreciable effect on the performance of the converter or on its output voltage.

Figure 4. Frequency limits and modes of operations

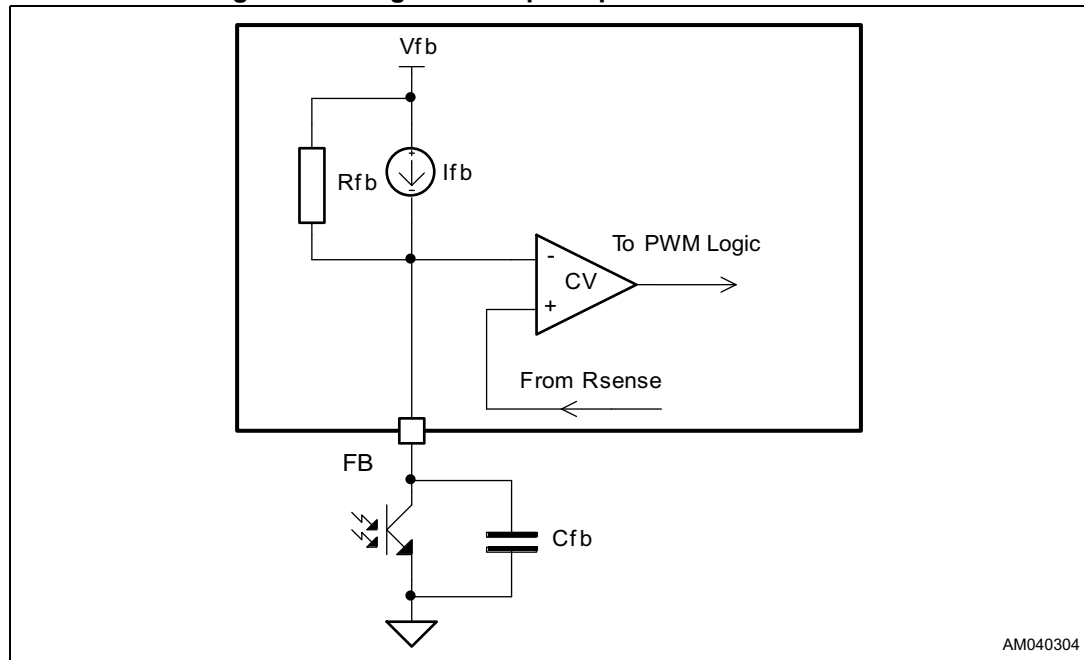


6.5 Constant voltage operation

The device is specific for the secondary feedback. The FB pin is connected to an optocoupler which transmits the error signal from the regulation loop located on the secondary side of the converter. Typically, a TS431 is used as a voltage reference.

The FB pin is driven directly by the phototransistor's collector to modulate the duty cycle. The voltage coming from the FB pin is compared with the voltage across the sense resistor, controlling the peak drain current cycle-by-cycle.

Figure 5. Voltage control principle: internal schematic



6.6 Constant current operation

The voltage of the auxiliary winding is fed into the internal CC block through the ZCD pin to achieve an output constant current regulation.

[Equation 1](#) can be used to define the output current in the CC-mode.

Equation 1

$$I_{OUT} = \frac{N_{PRI}}{N_{SEC}} \cdot \frac{K_I}{2 \cdot R_{SENSE}}$$

This formula shows that the average output current does not depend anymore on the input or the output voltage, neither on transformer inductance values. The external parameters defining the output current are the transformer ratio and the sense resistor R_{SENSE} . The current loop gain K_I is internally defined.

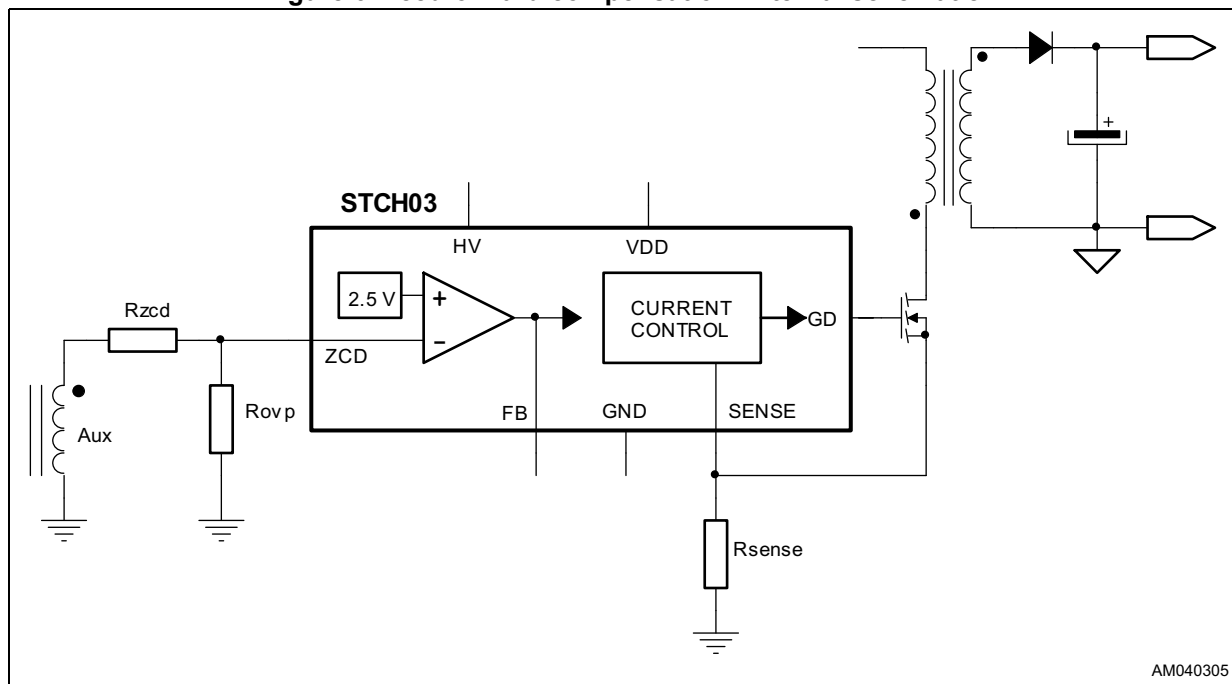
6.7 Voltage feedforward block

The current control structure uses the internal voltage V_C to define the output current, according to [Equation 1](#). Actually, the CC comparator will be affected by an internal propagation delay T_d , which will switch off the MOSFET with a peak current higher than the foreseen value.

The STCH03 device implements a line feedforward function, which solves the issue by introducing an input voltage dependent offset on the current sense signal, in order to adjust the cycle-by-cycle current limitation.

The external schematic configuration is shown in [Figure 6](#).

Figure 6. Feedforward compensation: internal schematic



The R_{ZCD} resistor can be calculated as follows:

Equation 2

$$R_{ZCD} = \frac{N_{AUX}}{N_{PRI}} \cdot \frac{L_{PR} \cdot R_{FF}}{T_D \cdot R_{SENSE}}$$

where R_{FF} is an internal parameter, defined in [Table 5: Electrical characteristics on page 6](#).

In this case the peak drain current does not depend on input voltage anymore.

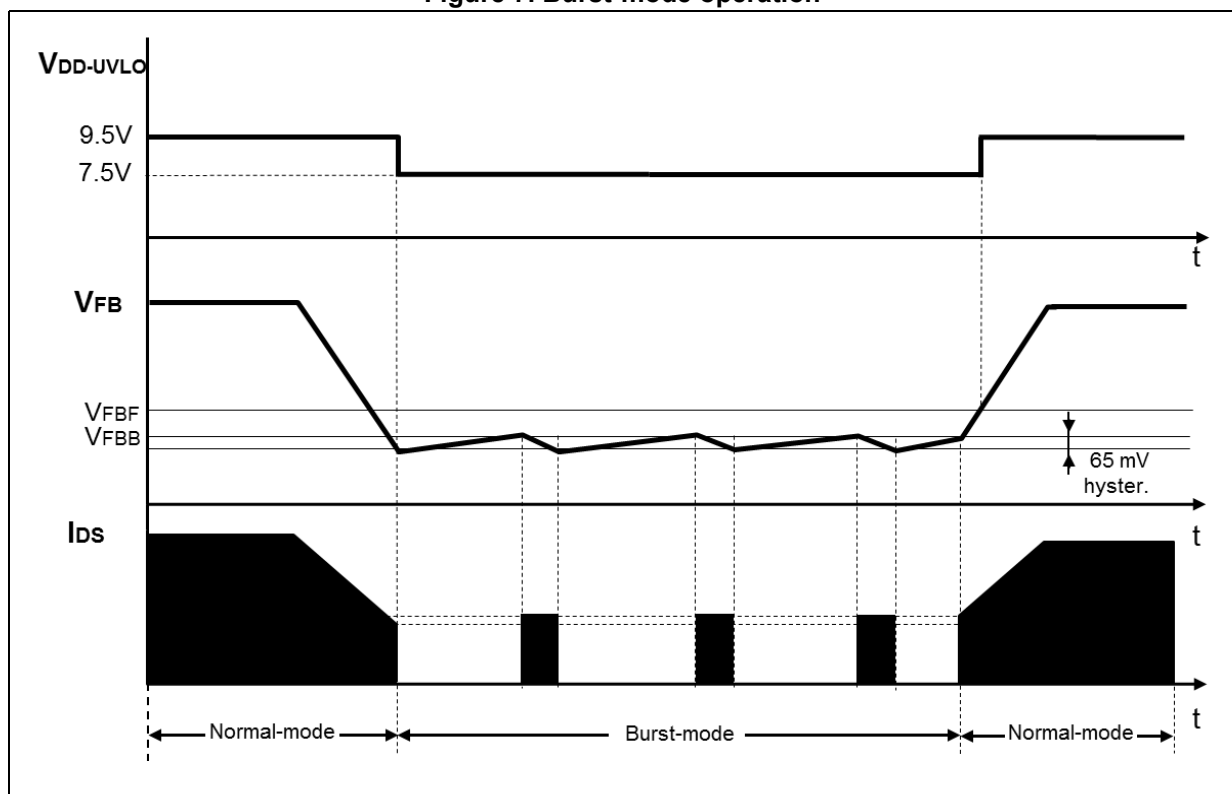
6.8 Burst-mode operation

When the voltage at the FB pin fall to 65 mV below V_{FBB} , the burst-mode operation starts: the MOSFET is turned OFF in order to reduce the consumption. After the MOSFET turns OFF, the FB pin voltage, as a result of the feedback reaction to the energy delivery stop, increase up to V_{FBB} and the device starts switching again.

During these switching cycles the max peak current is fixed (about V_{SENSE_BM}/R_{SENSE}) by an internal clamp inside the current limit circuit. The effect of the burst-mode operation is to reduce the equivalent switching frequency, which can go down even to few hundred hertz, minimizing all frequency related losses and making it easier to comply with energy saving regulations.

This kind of operation, shown in the timing diagrams of [Figure 7](#) along with the other ones, is audible noise-free since the peak current is low.

Figure 7. Burst-mode operation



6.9 Adaptive UVLO

A major problem when optimizing a converter for minimum no-load consumption is that the voltage generated by the auxiliary winding under these conditions falls considerably as compared even to a few mA load. This very often causes the supply voltage VDD of the control IC to drop below the UVLO threshold so that the operation becomes intermittent, which is undesired.

Furthermore, this must be traded off against the need of generating a voltage not exceeding the maximum allowed by the control IC at full load but low enough to reduce the bias losses as much as possible.

To help the designer overcome this problem the device, besides reducing its own consumption during the burst-mode operation, also features a proprietary adaptive UVLO function.

It consists of shifting the $V_{DD-UVLO}$ threshold downwards at the light load, namely when the voltage at the pin FB falls 65 mV below the burst-mode threshold V_{FBB} (0.6 V typ.), to have more headroom.

To prevent any malfunction the normal threshold (9.5 V typ.) is re-established when the voltage at the pin FB exceeds the exit burst-mode threshold V_{FBF} .

The normal UVLO threshold ensures that at full medium-heavy loads the MOSFET will be driven with a proper gate-to-source voltage. The mode of the operation is reported in [Figure 7](#).

6.10 Overvoltage protection

The overvoltage function of the STCH03 device monitors the voltage on the ZCD pin during MOSFET's OFF-time, where the voltage generated by the auxiliary winding tracks the converter output voltage. If the voltage applied to the pin exceeds an internal 2.5 V reference, a comparator is triggered, an overvoltage condition is assumed and the device is shut down.

Once R_{ZCD} is fixed by feedforward considerations (see [Section 6.7: Voltage feedforward block](#)), it is possible to calculate the value of the R_{OVP} resistor to activate the OVP protection for a certain output voltage level, $V_{OUT-OVP}$:

Equation 3

$$R_{OVP} = \frac{V_{OVP}}{\frac{N_{AUX}}{N_{SEC}} \cdot V_{OUT-OVP} - V_{OVP}} \cdot R_{ZCD}$$

where V_{OVP} is the internal OVP threshold, N_{SEC} and N_{AUX} are the secondary and auxiliary turns number respectively.

To reduce sensitivity to noise and prevent the protection from being erroneously activated, the OVP comparator must be triggered for four consecutive oscillator cycles before the STCH03 is stopped. A counter, which is reset every time the OVP comparator is not triggered in one oscillator cycle, is provided to this purpose.

The IC is provided with an internal bit option, intended to select the OVP function to work in the auto-restart mode or in the latch mode. This choice is taken during the final test and the mode of operation cannot be changed anymore by the final user.

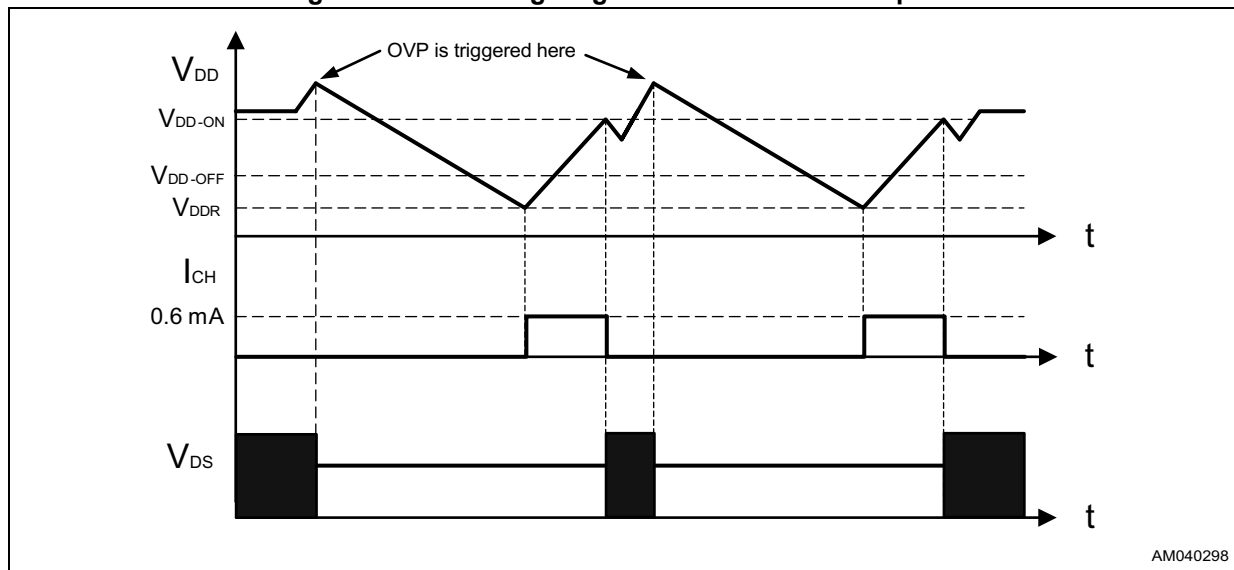
In the auto-restart mode, once the protection is tripped, the switching activity is stopped and the condition is maintained until V_{DD} goes below to V_{DDR} restart voltage and then rises-up again to V_{DD-ON} . Ultimately, this will result in a low-frequency intermittent operation (hiccup-mode operation), see [Figure 8](#).

In the latched mode the protection is maintained until the input main is removed. During this time the HV generator is activated periodically to recycle the supply voltage between V_{DD-ON} and V_{DD-OFF} . And the condition is indefinitely maintained until the AC main is removed and the V_{DD} voltage falls below V_{DDR} which resets the latch.

The latched OVP protection operation is shown in the time diagram of [Figure 9](#).

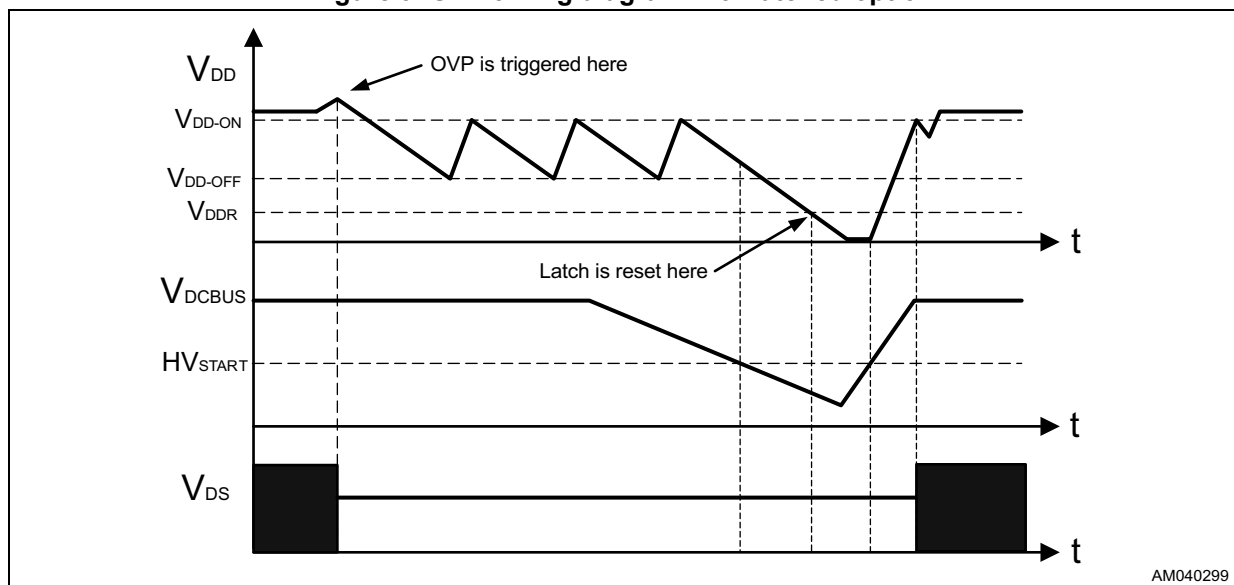
[Figure 10](#) illustrates the timing of the function.

Figure 8. OVP timing diagram with auto-restart option



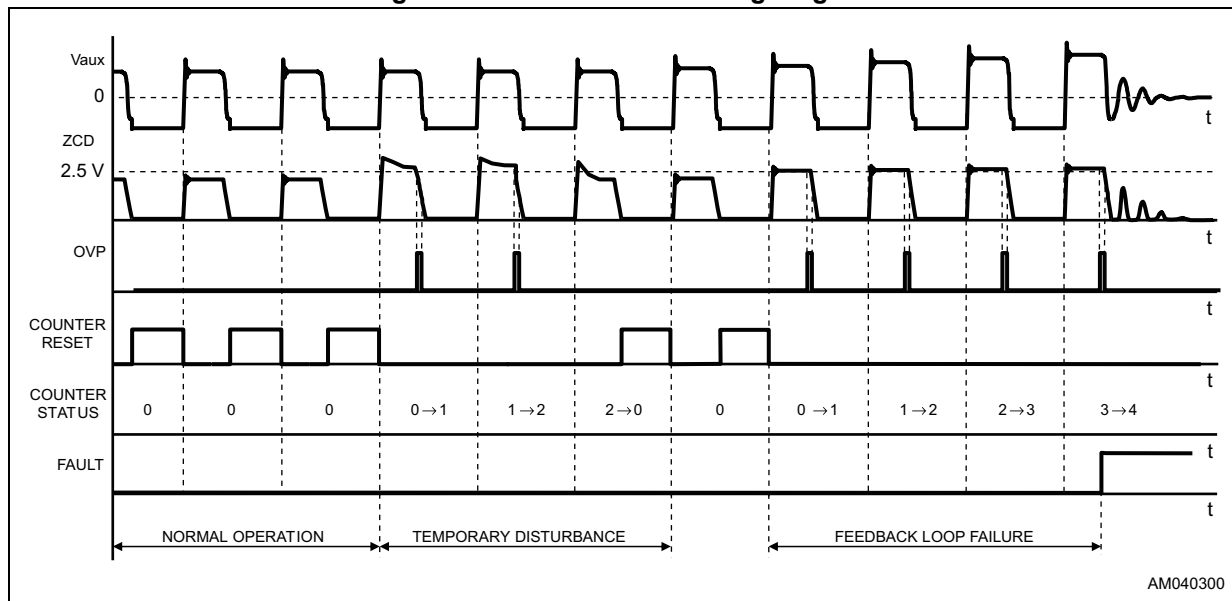
AM040298

Figure 9. OVP timing diagram with latched option



AM040299

Figure 10. OVP function: timing diagram



6.11 Output undervoltage protection

The output undervoltage function (UVP) of the STCH03 device protects the converter in case of the output short-circuit or for the CC-mode operation at low output voltage, forcing the system in the hiccup-mode.

The voltage on the ZCD at the end of the transformer's demagnetization is monitored and compared with an internal threshold, V_{UVP} (0.55 V typ.). If the value goes down to the threshold, an output undervoltage condition is assumed and the device enters in hiccup-mode protection.

Similar to OVP, also the UVP protection must be triggered for four consecutive oscillator cycles before the STCH03 is stopped, in order to provide better noise immunity against false protection triggering.

A 20 ms (typ. value) UVP blanking time is provided to delay the protection during converter power-on and at any restart after protection, to avoid erroneous UVP triggering during the output voltage rise time.

Note that OVP and UVP cannot be defined independently but are in tracking between they.

Once the OVP is fixed using [Equation 3](#), the output voltage level to activate the UVP ($V_{OUT-UVP}$) is:

Equation 4

$$V_{OUT-UVP} = \frac{N_{SEC}}{N_{AUX}} \cdot \left(\frac{R_{OVP} + R_{ZCD}}{R_{OVP}} \right) \cdot V_{UVP}$$

6.12 Soft-start and starter block

The soft-start feature is automatically implemented by the constant current block, as the primary peak current will be limited from the voltage on the internal CC block capacitor.

During the start-up, as the output voltage is zero, the IC will start in the CC-mode with no high peak current operations. In this way the voltage on the output capacitor will increase slowly and the soft-start feature will be ensured.

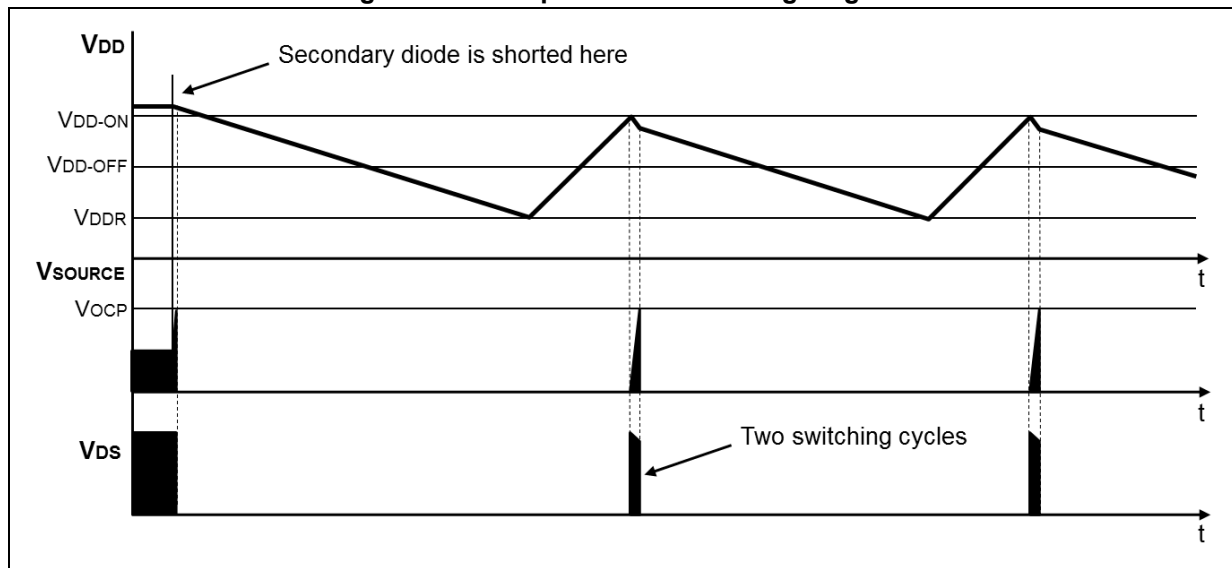
6.13 Overcurrent protection (OCP)

The device is also protected against the short-circuit of the secondary rectifier, the short-circuit on the secondary winding or a hard-saturated flyback transformer. A comparator monitors continuously the voltage on the R_{SENSE} and activates protection circuitry if this voltage exceeds the V_{OCP} value (1 V typ. value).

To distinguish an actual malfunction from a disturbance (e.g. induced during ESD tests), the first time the comparator is tripped the protection circuit enters a “warning state”. If in the subsequent switching cycle the comparator is not tripped, a temporary disturbance is assumed and the protection logic will be reset in its idle state; if the comparator trips again a real malfunction is assumed and the device will be stopped.

Once the protection is tripped, the condition is maintained until V_{DD} goes below V_{DDR} restart voltage. While it is disabled, however, no energy is coming from the auxiliary winding; hence the voltage on the V_{DD} capacitor will decay and cross the UVLO threshold after some time, which clears the latch. The internal start-up generator is still off, then the V_{DD} voltage still needs to go below its restart voltage before the V_{DD} capacitor is charged again and the device restarted. Ultimately, this will result in a low-frequency intermittent operation (hiccup-mode operation), with very low stress on the power circuit. This special condition is illustrated in the timing diagram of [Figure 11](#).

Figure 11. Hiccup-mode OCP: timing diagram



6.14 Thermal shutdown protection

When the IC temperature exceeds the shutdown threshold, T_{SD} (150 °C typ.) the device is shut down to prevent any dangerous overheating for the system and the V_{DD} pin will be continuously recycled between V_{DD-ON} and V_{DDR} to keep the controller alive.

Once the temperature falls T_{HYST} below restart time the IC will start again, unless the voltage on the V_{DD} pin is below $V_{DD-UVLO}$. In this case the pin is discharged down to V_{DDR} and recycled to V_{DD-ON} before to start again.

This operation is shown in [Figure 12](#).

Figure 12. OTP timing diagram with auto-restart option

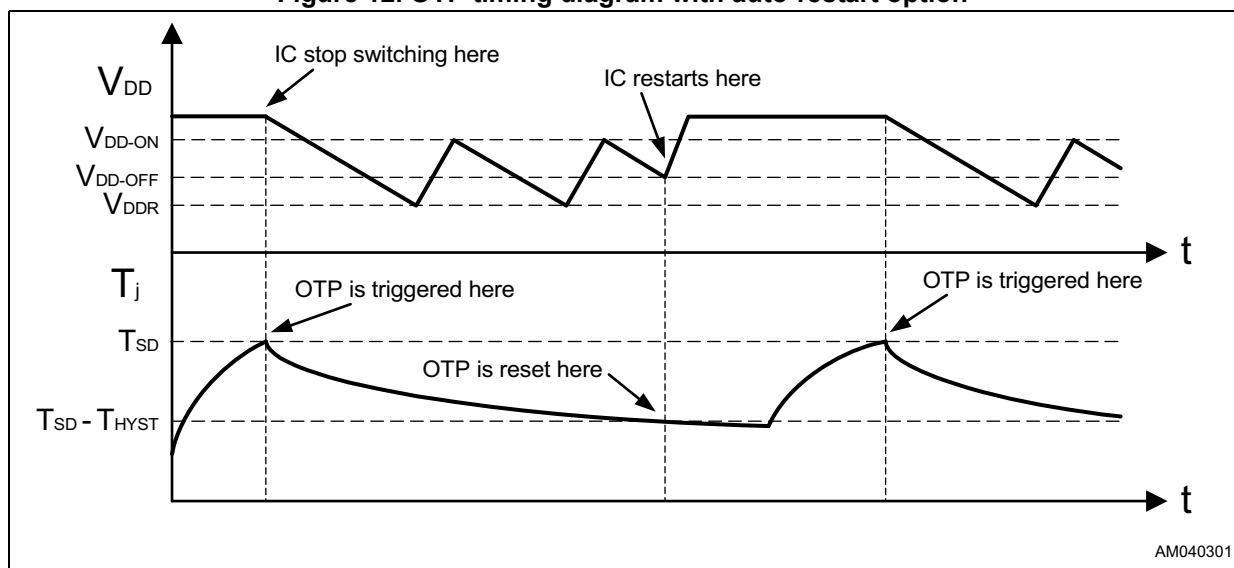
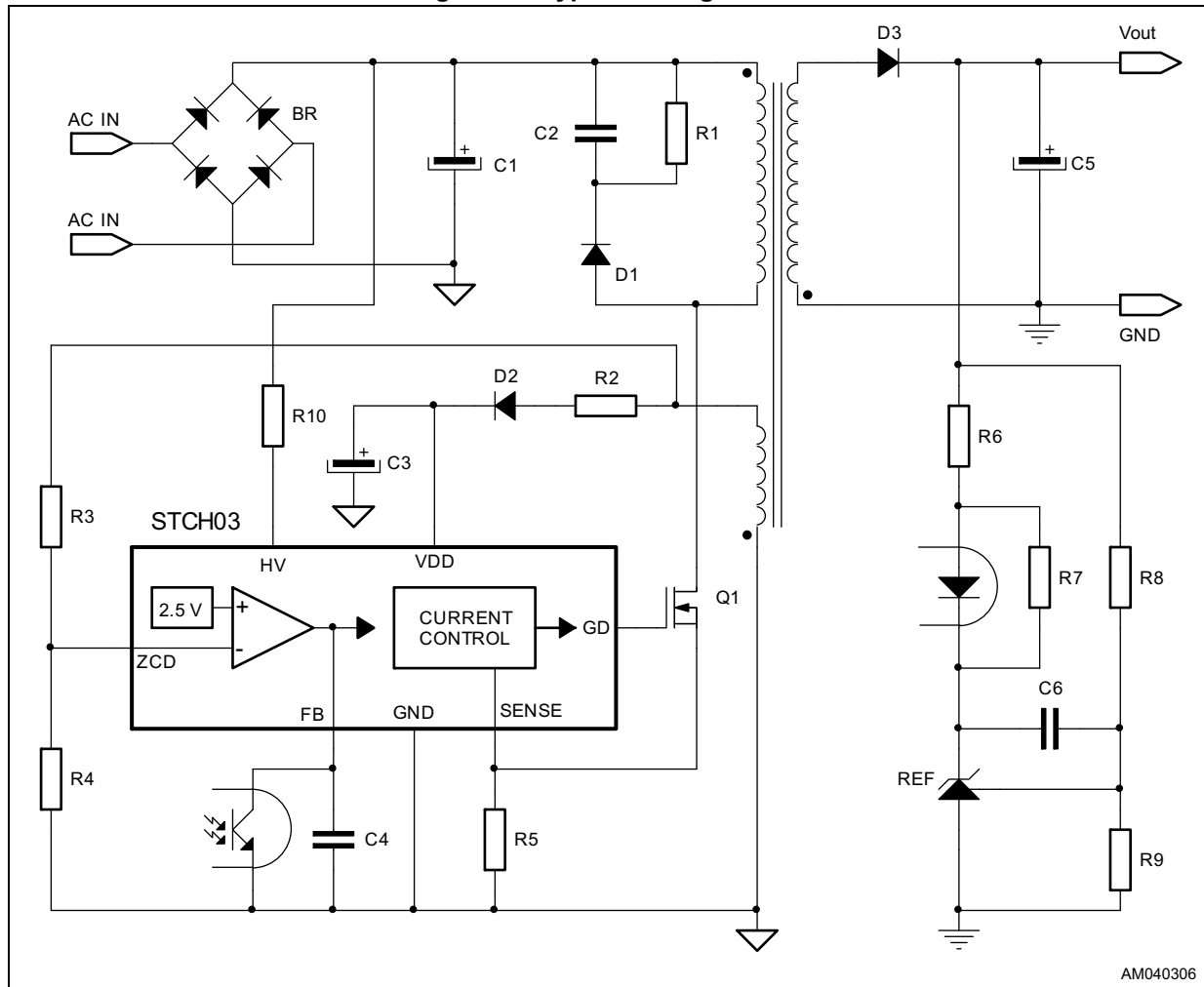


Figure 13. Typical configuration



7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

7.1 SO8 package information

Figure 14. SO8 package outline

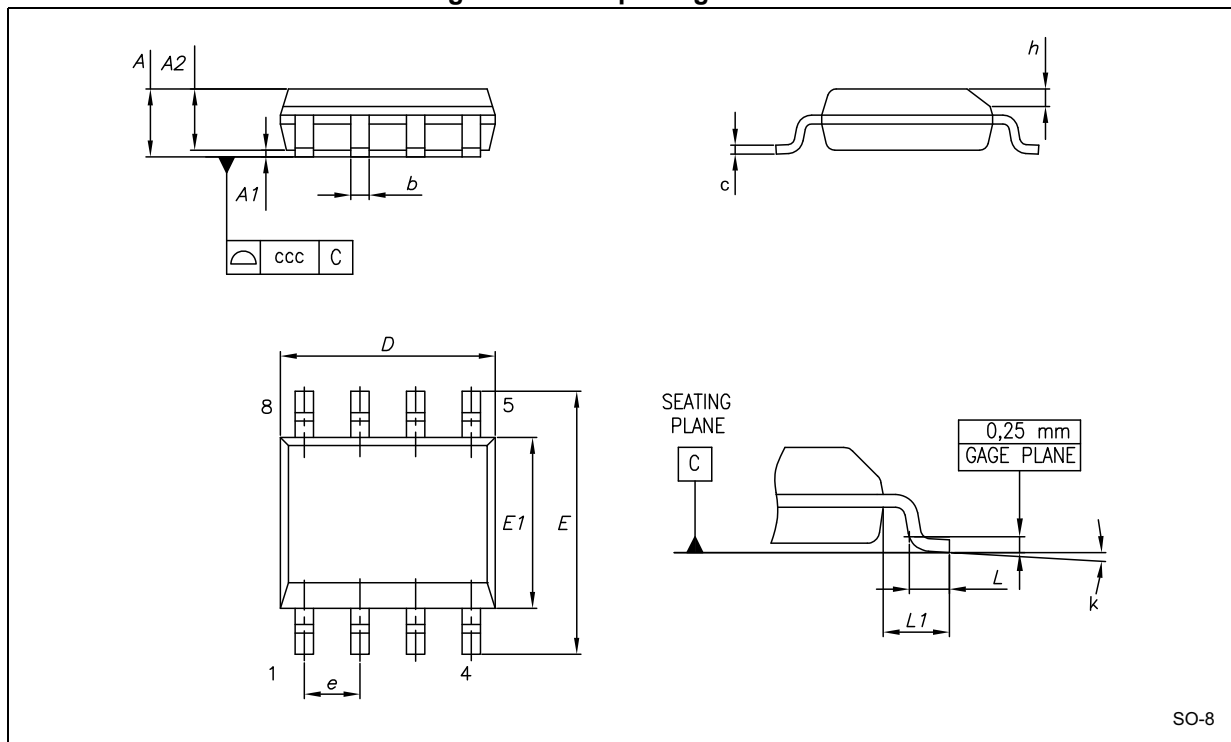


Table 6. SO8 package mechanical data

| Symbol | Dimensions (mm) | | | Note |
|--------|------------------|------|------|------|
| | Min. | Typ. | Max. | |
| A | - | - | 1.75 | - |
| A1 | 0.10 | - | 0.25 | - |
| A2 | 1.25 | - | - | - |
| b | 0.28 | - | 0.48 | - |
| c | 0.17 | - | 0.23 | - |
| D | 4.80 | 4.90 | 5.00 | (1) |
| E | 5.80 | 6.00 | 6.20 | - |
| E1 | 3.80 | 3.90 | 4.00 | (2) |
| e | - | 1.27 | - | - |
| h | 0.25 | - | 0.50 | - |
| L | 0.40 | - | 1.27 | - |
| L1 | - | 1.04 | - | - |
| k | 0 | - | 8 | (3) |
| ccc | - | - | 0.10 | - |

1. The dimension "D" does not include the mold flash, protrusions or gate burrs. The mold flash, protrusions or gate burrs shall not exceed 0.15 mm in total (both sides).
2. The dimension "E1" does not include the interlead flash or protrusions. The interlead flash or protrusions shall not exceed 0.25 mm per side.
3. Degrees.

8 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|-----------------|------------------|
| 02-May-2018 | 1 | Initial release. |

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